

MODEL NO. : TM060RDH01

ISSUED DATE: 2009-12-31

VERSION : Ver 2.1

□ Preliminary Specification
■ Final Product Specification

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Approved by	Notes
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SHANGHAI TIANMA Confirmed:

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2010,1.18	2010-01-15	

This technical specification is subjected to change without notice



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Record of Revision

1.1 2009-9-21 Update Gamma Correction Voltage Setting Fengxiang 2.0 2009-10-28 Final Specification Release Fengxiang 1 view angles (LVD/L/D) update: 60/70/75/75 to 60/70/70/70	Rev	Issued Date	Description	Editor
2.0 2009-10-28 Final Specification Release Fengxiang 3.1 2009-13-31 1.view angles(U/D/L/R) update:60/70/75/75 to 60/70/70/70 Haitag Ch	1.0	2009-07-17	Preliminary Specification Release	Fengxiang Liu
1. view angles(U/D/L/R) update:60/70/75/75 to 60/70/70/70	1.1	2009-9-21	Update Gamma Correction Voltage Setting	Fengxiang Liu
2.1 2009-12-31	2.0	2009-10-28	Final Specification Release	Fengxiang Liu
	2.1	2009-12-31	1.view angles(U/D/L/R) update:60/70/75/75 to 60/70/70/70 2.add driving backlight life time(20,000Hrs typ)	Haitao Chen





1 General Specifications

	Feature	Spec
	Size	6.0 inch
	Resolution	800(RGB) x 480
	Interface	TTL RGB 24 bits
	Color Depth	16M
	Technology Type	a-Si
Display Spec.	Pixel Pitch (mm)	0.1665x0.1538
	Pixel Configuration	R.G.B. Vertical Stripe
	Display Mode	TM with Normally White
	Surface Treatment(Up Polarizer)	Anti Glare
	Viewing Direction	12 o'clock
	Gray Scale Inversion Direction	6 o'clock
	LCM (W x H x D) (mm)	145.50x87.80x5.40
	Active Area(mm)	133.20x73.80
Mechanical Characteristics	With /Without TSP	Without TSP
	Weight (g)	113.25g
	LED Numbers	21 LEDs

Note 1: Viewing direction for best image quality is different from TFT definition. There is a 180 degree shift.

Note 2: Requirements on Environmental Protection: Q/S0002

Note 3: LCM weight tolerance: +/- 5%



2 Input/Output Terminals

2.1 CN1 of FPC

Matching Connector of FH28S-60S-0.5SH (HIROSE)

Pin	Symbol	I/O	Description	Remark	
1	AGND	Р	Ground		
2	AVDD	Р	Analog Power		
3	VCC	Р	Digital Power Supply		
4	R0	I	Red Data(LSB)		
5	R1	I	Red Data		
6	R2	I	Red Data		
7	R3	I	Red Data		
8	R4	I	Red Data		
9	R5	I	Red Data		
10	R6	I	Red Data		
11	R7	I	Red Data		
12	G0	I	Green Data(LSB)		
13	G1	I	Green Data		
14	G2	I	Green Data		
15	G3	I	Green Data		
16	G4	I	Green Data		
17	G5	I	Green Data		
18	G6	1	Green Data		
19	G7	I	Green Data		
20	B0	I	Blue Data(LSB)		
21	B1	I	Blue Data		
22	B2	I	Blue Data		
23	B3	I	Blue Data		
24	B4	I	Blue Data		
25	B5	I	Blue Data		
26	B6	I	Blue Data		
27	В7	I	Blue Data		
28	DCLK	I	Clock Input		



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V s	SHANGHAI TIAN	IMA MIC	RO-ELECTRONICS	ГM060RDH01	V2.1
29	DE	I	Data Enable Signal		
30	HSD	I	Horizontal Sync Input. Negative Po	larity	
31	VSD	I	Vertical Sync Input. Negative Polar	ity	
32	MODE	I	DE/SYNC Mode Select. H: SYNC mode, L: DE mode		
33	RSTB	I	Global Reset Pin		
34	STBYB	I	Standby Mode Select H: normal operation, L: standby mo	ode	
35	SHLR	I	Source Right or Left Sequence Con	ntrol	
36	VCC	Р	Digital Power		
37	UPDN	I	Gate Up or Down Scan Control		
38	GND	Р	Ground		
39	AGND	Р	Ground		
40	AVDD	Р	Analog Power		
41	VCOM	I	Common Voltage Input		
42	DITH	I	Dithering Setting. H: 6bit Resolution, L: 8bit Resolution	on	
43	NC	N	No Connection		
44	NC	N	No Connection		
45	V10	I	Gamma Voltage 10		
46	V9	I	Gamma Voltage 9		
47	V8	I	Gamma Voltage 8		
48	V7	I	Gamma Voltage 7		
49	V6	I	Gamma Voltage 6		
50	V5	I	Gamma Voltage 5		
51	V4	I	Gamma Voltage 4		
52	V3	I	Gamma Voltage 3		
53	V2	I	Gamma Voltage 2		
54	V1	I	Gamma Voltage 1		
55	NC	N	No Connection		
56	VGH	Р	Positive Power for TFT		
57	VCC	Р	Digital Power		
58	VGL	Р	Negative Power for TFT		
59	GND	Р	Ground		



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60 NC N No Connection

Note: I/O definition.

I---Input pin, O---Output pin, P--- Power/Ground, N--- No Connection

2.2 CN2 of LED BLU Connector

Matching Connector of BHSR-02VS-1

Pin	Symbol	I/O	Description	Remark
1	LED+	Р	LED Anode	Red Cable
2	LED-	Р	LED Cathode	White Cable

2.3 U/D R/L Function Description

Scan Co	ntrol Input	Scanning Direction		
UPDN	SHLR	Scalling Direction		
GND	VCC	Up to Down, Left to Right		
VCC	GND	Down to Up, Right to Left		
GND	GND	Up to Down, Right to Left		
VCC	VCC	Down to Up, Left to Right		

Absolute Maximum Ratings

AGND= GND=0V, Ta = 25°C

Item	Symbol	Min	Max	Unit	Remark
	VCC	-0.50	5.00	V	
	AVDD	-0.50	13.50	V	
Power Voltage	VGH	-0.30	40.00	V	
	VGL	-20.00	0.30	V	
	VGH-VGL	-0.30	40.00	V	
Backlight Forward Current	I _{LED}	-	25.0	mA	For each LED
Operating Temperature	T _{OPR}	-20.0	70.0	$^{\circ}$	
Storage Temperature	T _{STG}	-30.0	80.0	$^{\circ}$	



4 Electrical Characteristics

4.1 Recommended Operating Condition

AGND=GND=0V, Ta = 25°C

	Item	Symbol	Min	Tvn	Max	Unit	Remark
		Symbol	IVIIII	Тур	IVIAX	Ullit	Remark
Digital Solution	upply	VCC	3.00	3.30	3.60	V	
Analog S Voltage	Supply	AVDD	(9.310)	(9.840)	(10.290)	V	
Gate On	Voltage	VGH	(17.10)	(19.00)	(22.50)	V	
Gate Off	Voltage	VGL	(-7.70)	(-7.00)	(-6.30)	V	
Commor Electrode Driving S	е	VCOM	-	3.86	-	V	
Input Lev		V1~V5	0.4xAVDD	-	AVDD-0.1	V	
Gamma	Voltage	V6~V10	0.1	-	0.6xAVDD	V	
Input	Low Level	V _{IL}	0	-	0.3xVCC	V	R0~R7,G0~G7,B0~B7,DE, DCLK,HSD,VSD,MODE,
Signal Voltage	High Level	V _{IH}	0.7xVCC	ı	VCC	V	RSTB,STBYB,SHLR,UPDN, VCOM,DITH,V1~V10
Output Signal Voltage	Low Level	V _{OL}	0	ı	0.2xVCC	V	
	High Level	V _{OH}	0.8xVCC	-	VCC	V	

Note: The value is for design stage only.

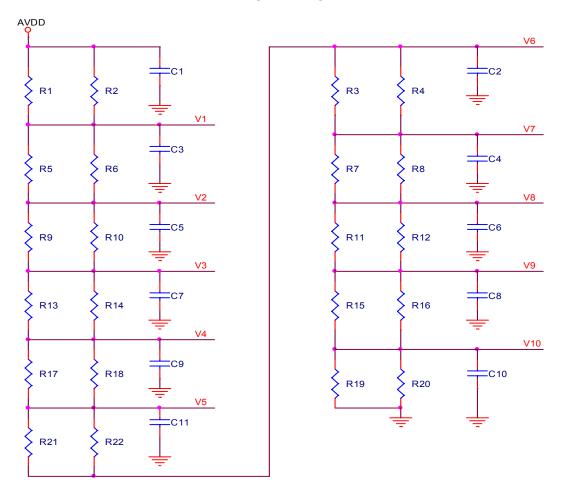
4.2 Gamma Correction Voltage Setting

4.2.1 Gamma Correction Reference Voltage Setting

Parameter	Symbol	MIN	TYP	MAX	Unit	Remark
	V1	-	9.60	AVDD-0.1	V	
	V2	-	7.89	-	V	
	V3	-	7.34	-	V	
	V4	-	6.92	-	V	
Gamma	V5	-	5.00	-	V	
correction reference	V6	-	4.83	-	V	
voltage	V7	-	2.95	-	V	
V1~V14	V8	-	2.49	-	V	
	V9	-	1.94	-	V	
	V10	AGND+0.1	0.23	-	V	



4.2.2 Gamma Correction Reference Voltage Setting



4.2.3 Gamma Correction Resistance Value

4.2.3 Gailling Correction Resistance value								
Symbol	Unit	Resistance	Symbol	Unit	Resistance			
R1	Ω	39	R3	Ω	200			
R2	Ω	39	R4	Ω	3000			
R5	Ω	1000	R7	Ω	910			
R6	Ω	200	R8	Ω	43			
R9	Ω	91	R11	Ω	91			
R10	Ω	130	R12	Ω	130			
R13	Ω	43	R15	Ω	1000			
R14	Ω	910	R16	Ω	200			
R17	Ω	200	R19	Ω	43			
R18	Ω	3000	R20	Ω	47			
R21	Ω	33	C1~C10	uF	1.0 (16V)			
R22	Ω	33						

Note: Setting the resistance only when AVDD=9.840V, AGND=GND=0V;

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4.3 Recommended Driving Condition for Backlight

Ta=25°C

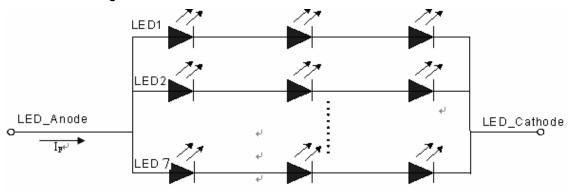
Item	Symbol	Min	Тур	Max	Unit	Remark
Forward Current	I _F	-	140.0	175.0	mA	
Forward Voltage	V _F	-	9.6	-	V	21 LEDs
Backlight Power Consumption	W _{BL}	-	1.344	1.680	W	(3 LED Serial, 7 LED Parallel)
Operating Life Time		10,000	20,000		Hrs	

Note1: The LED driving condition is defined for each LED module (3 LED Serial, 7 LED Parallel). For each LED: $I_F(1/7)=20$ mA, $V_F(1/3)=3.2$ V.

Note2: Under LCM operating, the stable forward current should be inputted. And forward voltage is for reference only.

Note3: I_F is defined for one channel LED.Optical performance should be evaluated at Ta=25 $^{\circ}$ C only. If LED is driven by high current, high ambient temperature & humidity condition. The life time of LED will be reduced.Operating life means brightness goes down to 50% initial brightness. Typical operating life time is estimated data.

Note4: The LED driving condition is defined for each LED module.

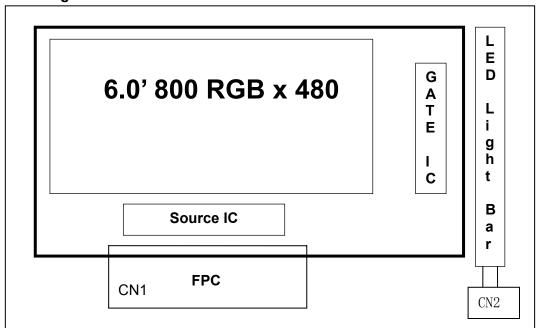


4.4 Power Consumption

AGND=GND=0V, Ta = 25°C

Item	Symbol	Condition	Min	Тур	Max	Unit	Remark
Digital Supply Current	I _{vcc}	VCC=3.3V	-	5	(10.0)	mA	
Analog Supply Current	I _{AVDD}	AVDD=9.84V	-	25	(35.0)	mA	
Gate On Current	I _{VGH}	VGH=19.0V	-	0.4	(0.6)	mA	
Gate Off Current	I _{VGL}	VGL=-7.0V	-	0.4	(0.6)	mA	
	PanelΓ		-	0.3	-	W	
Power Consumption	Backlight		-	1.344	1.680	W	
	Total		-	1.644	-	W	

4.5 Block Diagram



V2.1



5 Timing Chart

5.1 TFT-LCD Input Timing

VCC=3.3V, AVDD=9.84V, AGND=GND=0V, Ta=25 $^{\circ}$ C

Parameter	Symbol	Min	Тур	Max	Unit	Conditions
DCLK Frequency	Fclk	-	30.0	40.0	MHz	
DCLK Cycle Time	Tcph	-	33.3	25	ns	
DCLK Pulse Width	Tcw	40%	50%	60%	Tcph	
VSD Setup Time	Tvst	8			ns	
VSD Hold Time	Tvhd	8	-	-	ns	
HSD Setup Time	Thst	8			ns	
HSD Hold Time	Thhd	8	-	-	ns	
Data Setup Time	Tdsu	8			ns	Data to DCLK
Data Hold Time	Tdhd	8	-	-	ns	Data to DCLK
DE Setup Time	Tesu	8	-	-	ns	
DE Hold Time	Tehd	8	-	-	ns	
POL Hold Time	Tphd	6	-	-	ns	
Output Stable Time	Tsst	ı	-	6	us	CL=120pF, R=10K 10% or 90%
HSD to Source Output	Thso	-	64	-	Tcph	
HSD to STV	Thstv	ı	2	-	Tcph	
HSD to CKV	Thckv	ı	20	-	Tcph	
HSD to LD	Thld	-	64	-	Tcph	
HSD to OEV	Thoev	-	4	-	Tcph	
LD Pulse Width	Twld	-	10	-	Tcph	
CKV Pulse Width	Twckv	-	66	-	Tcph	
OEV Pulse Width	Twoev	1	74	-	Tcph	
RSTB Pulse Width	Trst	50	-	-	us	
DE Setup Time	Tesu	8	-	-	ns	



Recommended Timing Setting Of TCON

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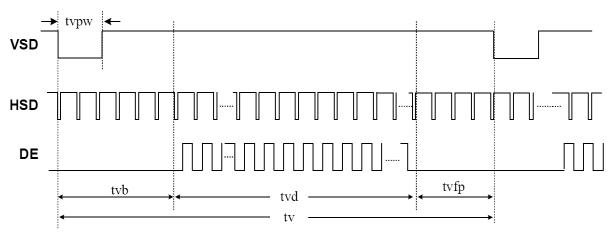
TCON (Embedded In Source IC) Input Timing (DCLK, HSD, VSD, DE)

VCC=3.3V, AVDD=9.84V, AGND=GND=0V, Ta=25°C

Parameter	Symbol	Min	Тур	Max	Unit	Remark
DCLK	Fclk	-	30.0	40.0	MHZ	
DOLK	tclk	-	33.3	25.0	ns	
	th	928	928	928	tclk	
	thd	800	800	800	tclk	
HSD	t hpw	1	48	-	tclk	
	t hb	-	88	-	tclk	
	thfp	-	40	-	tclk	
	tv	-	525	-	th	
	tvd	480	480	480	th	
VSD	tvpw	-	3	-	th	
	tvb	-	32	-	th	
	t∨fp	-	13	-	th	

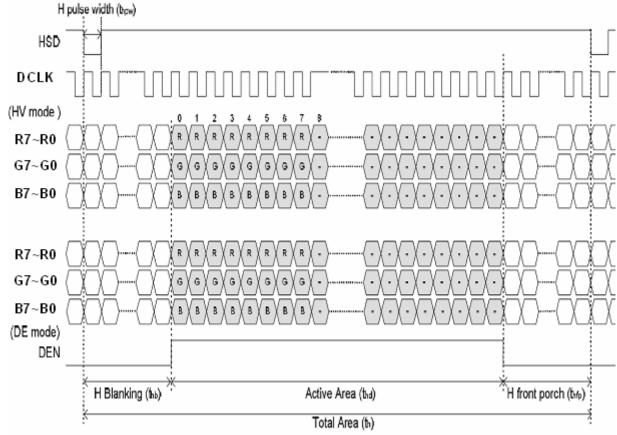
Note: DE timing refer to HSD, VSD input timing.

TCON Vertical Input Timing Diagram HV

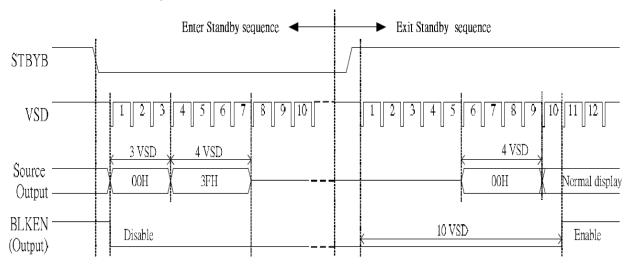




TCON Horizontal Input Timing Diagram

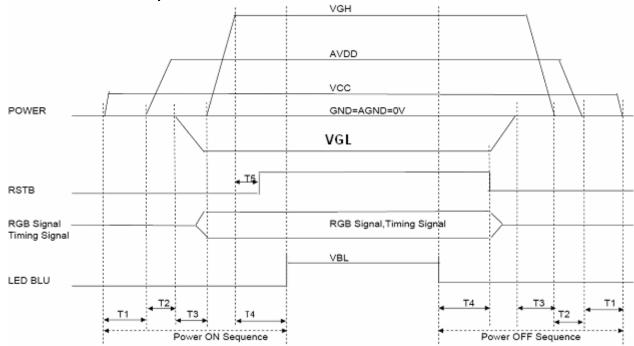


Enter and Exit Standby Mode Sequence





5.3 Power On/Off Sequence



Note: T1≥20ms, T2≥20ms, T3≥5ms, T4≥100ms, T5≥5ms.

6 Optical Characteristics

Ta=25°C

Item		Symbol	Condition	Min	Тур	Max	Unit	Remark
				50	60			
Viou Angles		θВ	CR≧10	60	70		Dograo	Note 2
View Angles		θL	OK≦ IU	60	70		Degree	Note 2
		θR		60	70			
Contrast Ratio)	CR	θ=()°	400	500			Note1 Note3
Response Tim	10	T _{ON}	25 ℃		20	30	ms	Note1
Response IIII	ic	T _{OFF}	250		20	30	1115	Note4
	White	Х		0.255	0.305	0.355		
		у	Backlight is on	0.280	0.330	0.380		Note5
	Red	х		0.530	0.580	0.630		
Chromaticity		у		0.300	0.350	0.400		
Chilomaticity	Green	х		0.295	0.345	0.395		Note1
		у		0.525	0.575	0.625		
	Blue	х		0.095	0.145	0.195		
	Dide	у		0.065	0.115	0.165		
Uniformity		U		75	80		%	Note1 Note6
NTSC					50		%	Note 5
Luminance		L		320	400		cd/m ²	Note1 Note7

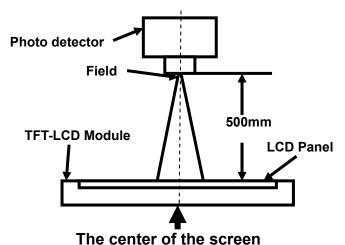
Test Conditions:

- 1. I_F = 140 mA, V_F =9.6 V,and the ambient temperature is 25°C.
- 2. The test systems refer to Note 1 and Note 2.



Note 1: Definition of optical measurement system.

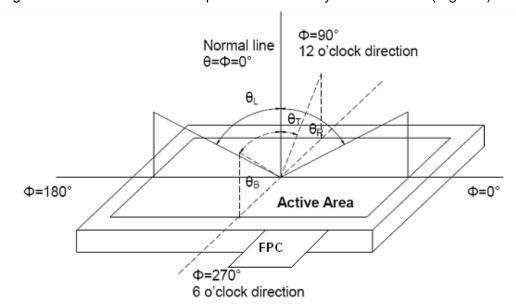
The optical characteristics should be measured in dark room. After 5 Minutes operation, the optical properties are measured at the center point of the LCD screen. All input terminals LCD panel must be ground when measuring the center area of the panel.



Item	Photo detector	Field
Contrast Ratio		
Luminance	SR-3A	1°
Chromaticity	SK-SA	
Lum Uniformity		
Response Time	BM-7A	2°
-		

Note 2: Definition of viewing angle range and measurement system.

viewing angle is measured at the center point of the LCD by CONOSCOPE(ergo-80).



Note 3: Definition of contrast ratio

Contrast ratio (CR) = $\frac{\text{Luminance measured when LCD is on the "White" state}}{\text{Luminance measured when LCD is on the "Black" state}}$

"White state ": The state is that the LCD should drive by Vwhite.

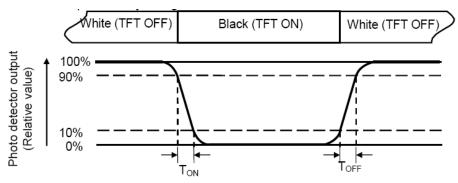
"Black state": The state is that the LCD should drive by Vblack.

Vwhite: To be determined Vblack: To be determined.

Note 4: Definition of Response time

The response time is defined as the LCD optical switching time interval between "White" state and

"Black" state. Rise time (T_{ON}) is the time between photo detector output intensity changed from 90% to 10%. And fall time (T_{OFF}) is the time between photo detector output intensity changed from 10% to 90%.



Note 5: Definition of color chromaticity (CIE1931)

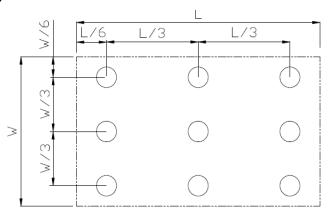
Color coordinates measured at center point of LCD.

Note 6: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (Refer Fig. 2). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity (U) = Lmin/Lmax

L----- Active area length W---- Active area width



Lmax: The measured Maximum luminance of all measurement position.

Lmin: The measured Minimum luminance of all measurement position.

Note 7: Definition of Luminance:

Measure the luminance of white state at center point.



Environmental / Reliability Test

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No	Test Item	Condition	Remarks
1	High Temperature Operation	Ts = +70℃, 240 hours	IEC60068-2-1:2007, GB2423.2-2008 Note1
2	Low Temperature Operation	Ta = -20°C, 240 hours	IEC60068-2-1:2007 GB2423.1-2008
3	High Temperature Storage	Ta = +80°C, 240 hours	IEC60068-2-1:2007 GB2423.2-2008
4	Low Temperature Storage	Ta = -30℃, 240 hours	IEC60068-2-1:2007 GB2423.1-2008
5	Storage at High Temperature and Humidity	Ta = +60°C, 90% RH max,240hours	IEC60068-2-78 :2001 GB/T2423.3—2006 Note2
6	Thermal Shock (non-operation)	-30°C 30 min~+80°C 30 min, Change time:5min, 100 Cycle	Start with cold temperature, End with high temperature, IEC60068-2-14:1984,GB242 3.22-2002
7	ESD	C=150pF,R=330Ω,5point/panel Air:±8Kv,5times; Contact:±4Kv,5times (Environment:15℃~35℃, 30%~60%.86Kpa~106Kpa)	IEC61000-4-2:2001 GB/T17626.2-2006
8	Vibration Test	Frequency range:10~55Hz Stroke:1.5mm Sweep:10Hz~55Hz~10Hz 2 hours for each direction of X.Y.Z. (6 hours for total)	IEC60068-2-6:1982 GB/T2423.10—1995
9	Mechanical Shock (Non Op)	Half Sine Wave 100G 6ms, ±X,±Y,±Z 3times for each direction	IEC60068-2-27:1987 GB/T2423.5—1995
10	Package Drop Test	Height:60cm, 1corner,3edges,6surfaces	IEC60068-2-32:1990 GB/T2423.8—1995

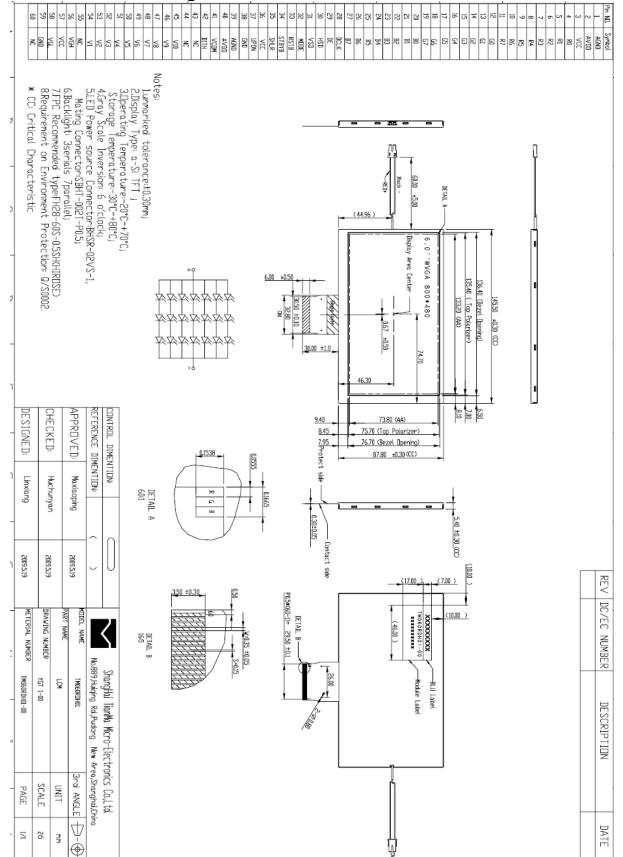
Note1: Ts is the temperature of panel's surface.

Note2: Ta is the ambient temperature of samples.



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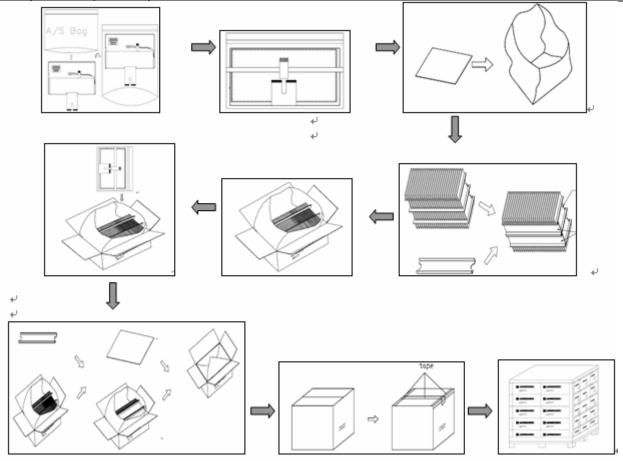
8 Mechanical Drawing





Packing Drawing

No	Item	Model(Material)	Dimensions (mm)	Unit Weigt (Kg)	Quantit y	Remar k	
1	L	CM	145.50x87.80x5.40	0.113	50		
2	Partition-1	Corrugated Paper	513x333x215	1.388	1	Anti-sta tic	
3	Anti-static Bag	PE	173x150x0.05	0.001	50	Anti-sta tic	
4	Dust-Proof Bag	PE	700x530	0.06	1		
5	Partition_2	Corrugated Paper	505x332x4.0	0.098	2		
6	Corrugated Paper	Corrugated Paper	513x100x30	0.048	4		
7	Carton	Corrugated Paper	530x350x250	1.12	1		
8	Total Weight (Kg)	8.656±5%					





10 Precautions for Use of LCD Modules

10.1 Handling Precautions

- **10.1.1** The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- **10.1.2** If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- **10.1.3** Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- **10.1.4** The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- **10.1.5** If the display surface is contaMinated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol
 - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- **10.1.6** Do not attempt to disassemble the LCD Module.
- **10.1.7** If the logic circuit power is off, do not apply the input signals.
- **10.1.8** To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - 10.1.8.1 Be sure to ground the body when handling the LCD Modules.
 - 10.1.8.2 Tools required for assembly, such as soldering irons, must be properly ground.
- 10.1.8.3 To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
- 10.1.8.4 The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

10.2 Storage precautions

- 10.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 10.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature : 0°C ~ 40°C Relatively humidity: ≤80%

10.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.

10.3 Transportation Precautions

10.3.1 The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.